



# BB170

## VHF variable capacitance diode

Rev. 1 — 25 March 2013

Product data sheet

## 1. Product profile

### 1.1 General description

The BB170 is a variable capacitance diode, fabricated in planar technology, and encapsulated in the SOD323 (SC-76) very small SMD plastic package.

### 1.2 Features and benefits

- Excellent linearity
- Very small SMD plastic package
- $C_{d(28V)} = 2.6 \text{ pF}$ ;  $C_{d(1V)}$  to  $C_{d(28V)}$  ratio = 15
- Low series resistance

### 1.3 Applications

- Voltage Controlled Oscillators (VCO)

## 2. Pinning information

Table 1. Pinning

Pin	Description	Simplified outline	Symbol
1	cathode	<a href="#">[1]</a>	 sym008
2	anode		

[1] The marking bar indicates the cathode.

## 3. Ordering information

Table 2. Ordering information

Type number	Package		
	Name	Description	Version
BB170	SC-76	plastic surface-mounted package; 2 leads	SOD323



## 4. Marking

**Table 3. Marking**

Type number	Marking code
BB170	4H

## 5. Limiting values

**Table 4. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

Symbol	Parameter	Conditions	Min	Max	Unit
$V_R$	reverse voltage		-	30	V
$I_F$	forward current		-	20	mA
$T_{stg}$	storage temperature		-55	+150	°C
$T_j$	junction temperature		-55	+125	°C

## 6. Characteristics

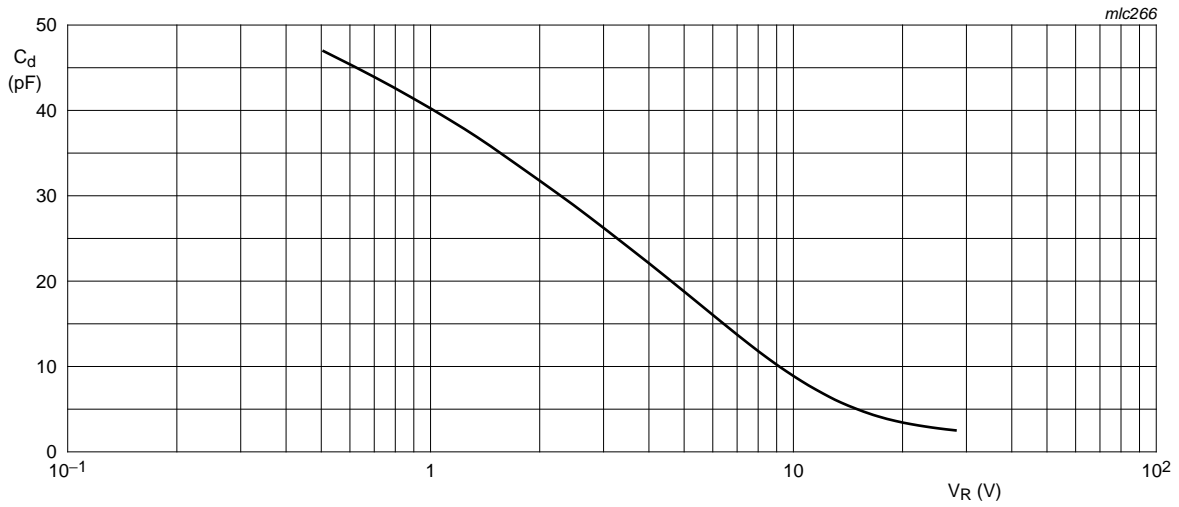
**Table 5. Characteristics**

*$T_j = 25\text{ °C}$  unless otherwise specified.*

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$I_R$	reverse current	$V_R = 30\text{ V}$	[1]	-	-	10 nA
		$V_R = 30\text{ V}; T_j = 85\text{ °C}$	[1]	-	-	200 nA
$r_s$	diode series resistance	$f = 100\text{ MHz}; C_d = 12\text{ pF}$	-	-	0.9	$\Omega$
$C_d$	diode capacitance	$f = 1\text{ MHz}$	[2]			
		$V_R = 1\text{ V}$	36.8	-	41.8	pF
		$V_R = 28\text{ V}$	2.4	2.6	2.75	pF
$C_{d(1V)}/C_{d(28V)}$	diode capacitance ratio (1 V to 28 V)	$f = 1\text{ MHz}$	14.5	15	-	

[1] See [Figure 2](#).

[2] See [Figure 1](#) and [Figure 3](#).



f = 1 MHz; T<sub>j</sub> = 25 °C.

Fig 1. Diode capacitance as a function of reverse voltage; typical values.

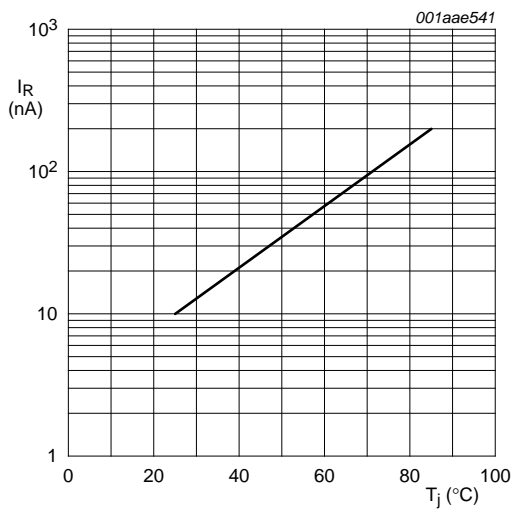
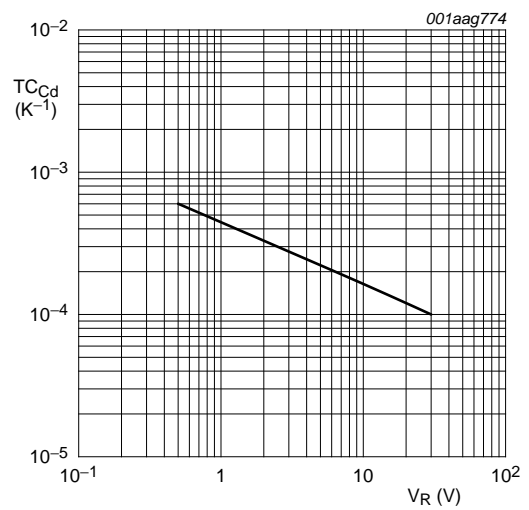


Fig 2. Reverse current as a function of junction temperature; maximum values.



T<sub>j</sub> = 0 °C to 85 °C.

Fig 3. Diode capacitance temperature coefficient as a function of reverse voltage; typical values.

7. Package outline

Plastic surface-mounted package; 2 leads

SOD323

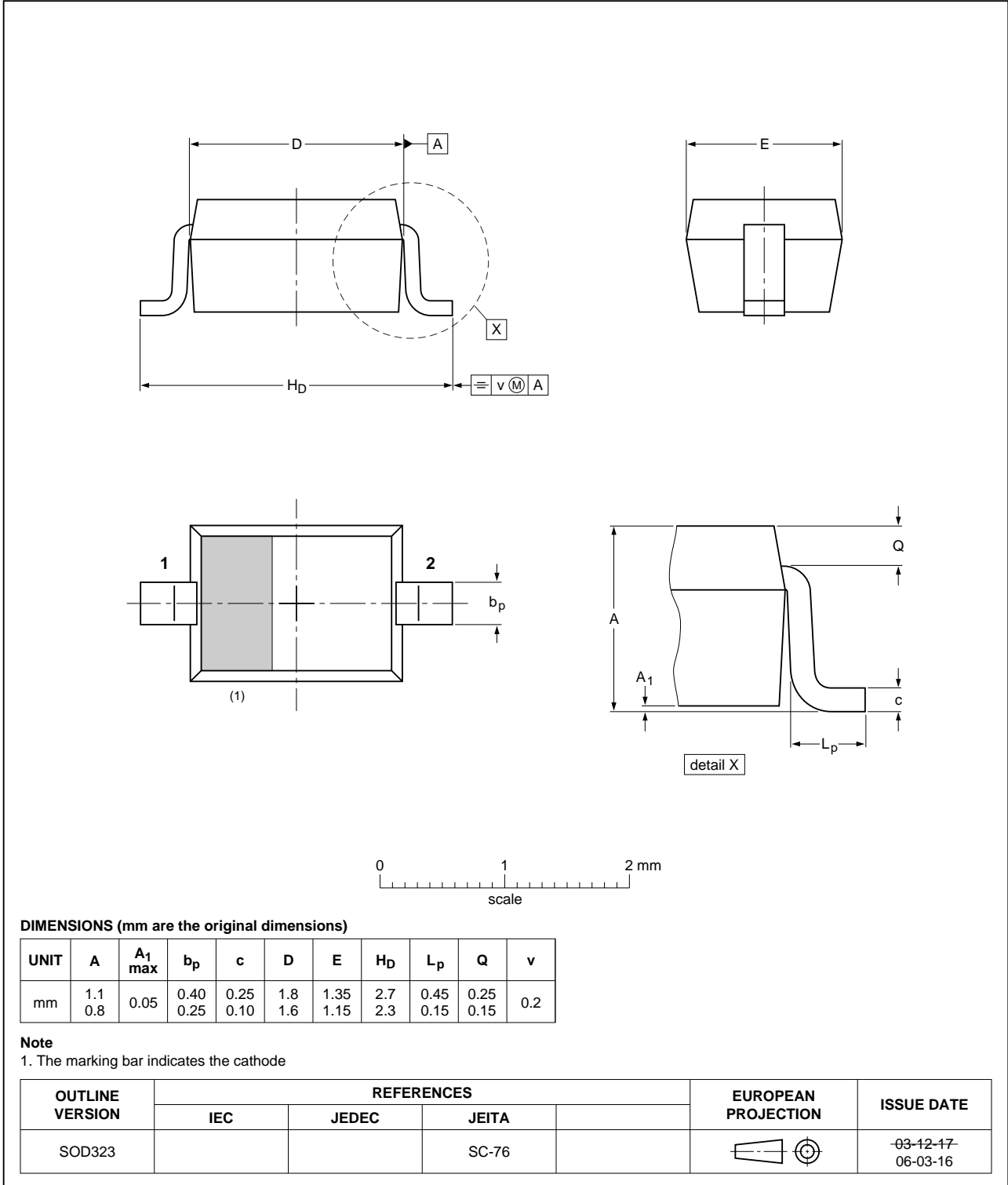


Fig 4. Package outline SOD323 (SC-76)

## 8. Abbreviations

Table 6. Abbreviations

Acronym	Description
SMD	Surface Mounted Device
VHF	Very High Frequency

## 9. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BB170 v.1	20130325	Product data sheet	-	-

## 10. Legal information

### 10.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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